

HAT2292C

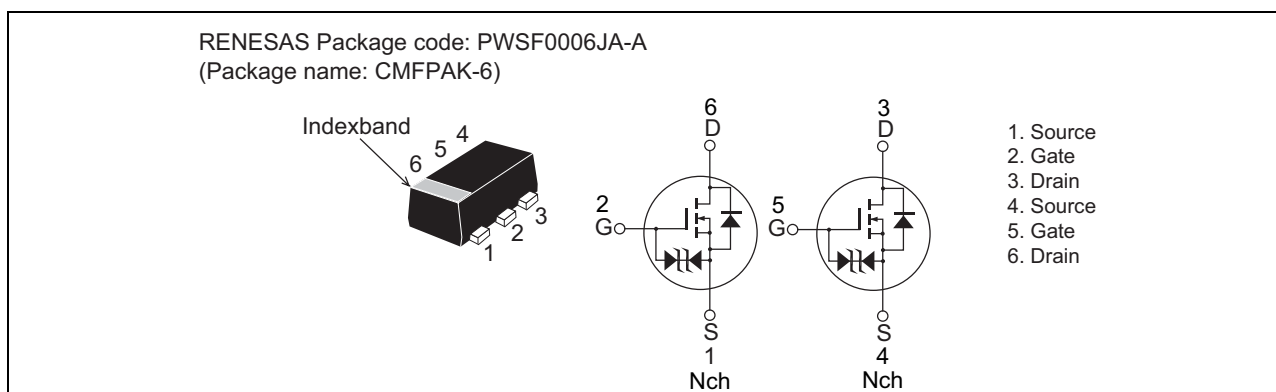
Silicon N Channel MOS FET
Power Switching

Rev.3
Jan.10.2007

Features

- 2 chips in 1 package
- 2.5V gate drive device
- Low on-resistance
- High density mounting

Outline



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source voltage	V_{DSS}	20	V
Gate to Source voltage	V_{GSS}	±12	V
Drain current	I_D	1.5	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	6	A
Body - Drain diode reverse Drain current	I_{DR}	1.5	A
Channel dissipation	P_{ch} ^{Note2}	650	mW
	P_{ch} ^{Note3}	900	mW
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$

2. 1 drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6mm), $PW \leq 10 s$

3. 2 drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6mm), $PW \leq 10 s$

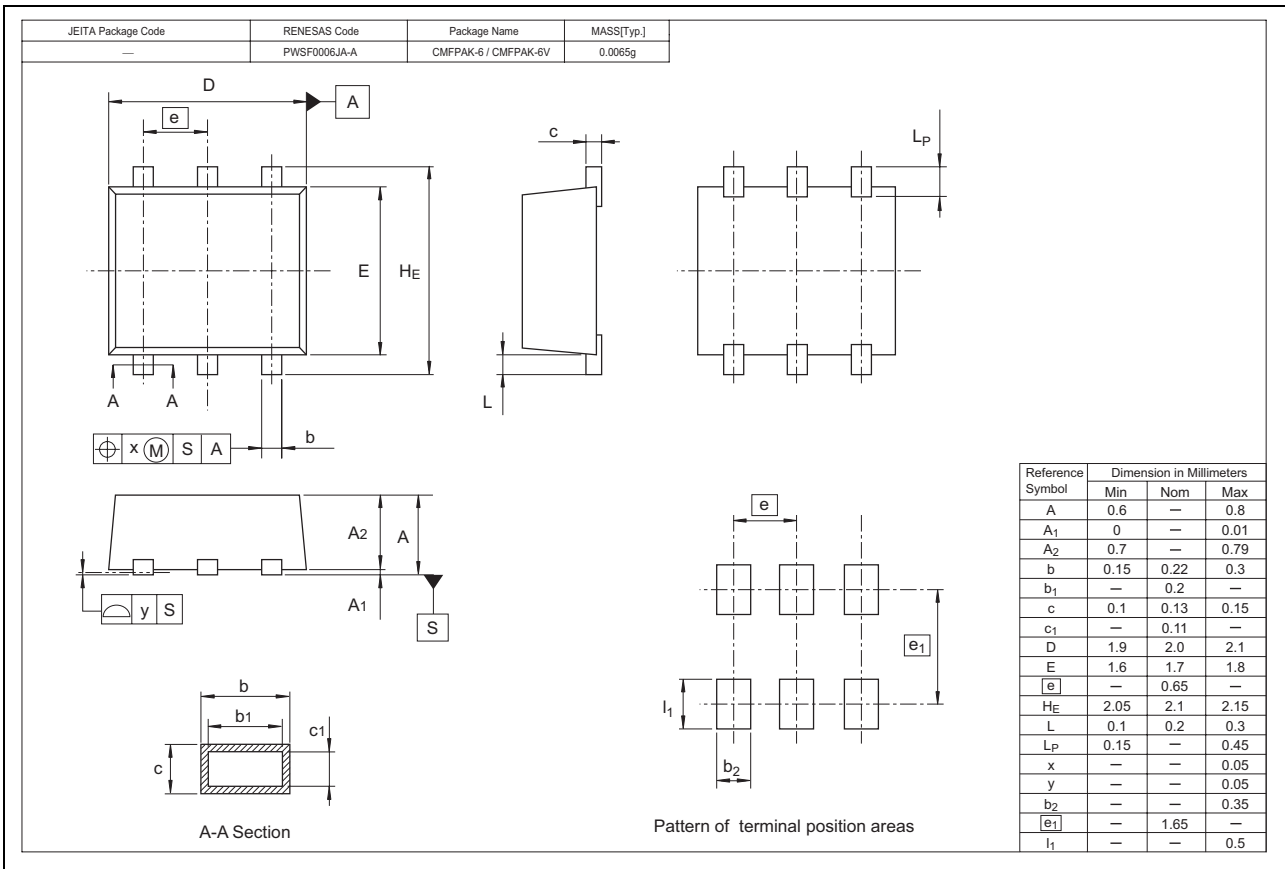
Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	20	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to Source breakdown voltage	$V_{(BR)GSS}$	± 12				$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to Source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 10 \text{ V}$, $V_{DS} = 0$
Drain to Source leak current	I_{DSS}	—	—	1	μA	$V_{DS} = 20 \text{ V}$, $V_{GS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Drain to Source on state resistance	$R_{DS(on)}$	—	165	205	$\text{m}\Omega$	$I_D = 0.8 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note4}
	$R_{DS(on)}$	—	255	370	$\text{m}\Omega$	$I_D = 0.8 \text{ A}$, $V_{GS} = 2.5 \text{ V}$ ^{Note4}
Forward transfer admittance	$ y_{fs} $	1.3	2	—	S	$I_D = 0.8 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note4}
Input capacitance	C_{iss}	—	70	—	pF	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	29	—	pF	
Reverse transfer capacitance	C_{rss}	—	10	—	pF	
Turn - on delay time	$t_{d(on)}$	—	14	—	ns	$V_{GS} = 4.5 \text{ V}$, $I_D = 0.8 \text{ A}$ $V_{DD} = 10 \text{ V}$ $R_L = 12.5 \text{ }\Omega$, $R_g = 4.7 \text{ }\Omega$
Rise time	t_r	—	12	—	ns	
Turn - off delay time	$t_{d(off)}$	—	50	—	ns	
Fall time	t_f	—	10	—	ns	
Total Gate charge	Q_g	—	1.1	—	nC	$V_{DD} = 10 \text{ V}$, $V_{GS} = 4.5 \text{ V}$ $I_D = 1.5 \text{ A}$
Gate to Source charge	Q_{gs}	—	0.3	—	nC	
Gate to Drain charge	Q_{gd}	—	0.4	—	nC	
Body - Drain diode forward voltage	V_{DF}	—	0.85	1.20	V	$I_F = 1.5 \text{ A}$, $V_{GS} = 0$ ^{Note3}

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2292C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.